

MXD8628

0.1-3.0GHz SP2T Switch

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General Description

The MXD8628 is a CMOS silicon-on-insulator (SOI), single-pole, double-throw (SP2T) transmitting and receiving switch. The high linearity performance and low insertion loss makes the device an ideal choice for GSM/WCDMA/LTE handset and data card applications.

The MXD8628 SP2T switch is provided in a compact LGA 9-pin 1.15mm x 1.15mm x 0.45mm package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

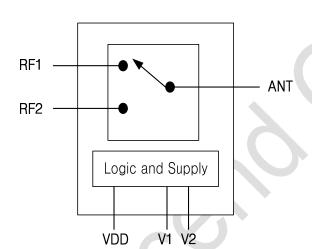
Applications

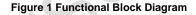
- GSM/WCDMA/LTE receive and transmit
- 802.11b/g/n WLANs

Features

- Broadband frequency range: 0.1 to 3.0 GHz
- Low insertion: 0.50 dB @ 2.7 GHz
- High isolation: 25 dB up to 2.7 GHz
- P0.1dB of 36dBm
- No external DC blocking capacitors required
- Positive low voltage control: VC = 1.6 to 3.00
 V, VDD = 2.5 to 3.0 V
- Small, LGA (9-pin, 1.15mm x 1.15mm x 0.45mm) package

Functional Block Diagram and Pin Function





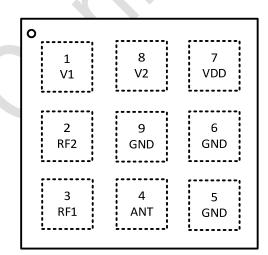


Figure 2 Pin-out (Top View)



Application Circuit

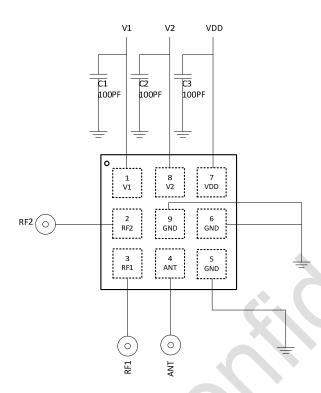


Figure 3 MXD8628 Application Circuit

Table 1. Pin Description

Table 1. Pin Description					
Pin No.	Name	Description	Pin No.	Name	Description
1	V1	Control Pin 1	6	GND	Ground
2	RF2	RF-Port 2	7	VDD	Power Supply
3	RF1	RF-Port 1	8	V2	Control Pin 2
4	ANT	Antenna	9	GND	Ground
5	GND	Ground			

Truth Table

Table 2.

V1	V2	Active Path
0	0	OFF
1	0	ANT to RF1
1	1	ANT to RF2

Note: "1" = 1.0 V to 3.00 V. "0" = 0 V to +0.3 V.

Recommended Operation Range

Table 3.

Parameters	Symbol	Min	Тур	Max	Units
Operation Frequency	f1	0.1	ı	3.0	GHz
Power supply	V_{DD}	2.5	2.8	3.0	V
Switch Control Voltage High	V_{CTL_H}	1.6	1.8	3.0	V
Switch Control Voltage Low	V_{CTL_L}	0	0	0.3	V



Specifications

Table 4.Electrical Specifications

Doromotor	Symbol	Specification		l lm!ta	Took Condition		
Parameter		Min.	Typical	Max.	Units	Test Condition	
DC Specifications	DC Specifications						
Control voltage: Low High	V _{CTL_L} V _{CTL_H}	0 1.60	+1.8	0.3 3.00	V		
Supply voltage	V _{DD}	2.5	2.8	3.0	V		
Supply current	IDD		40	60	uA	VDD = 2.8 V	
Control current	lctl		1		uA	VC= 1.8 V	
RF Specifications	5						
Insertion loss	IL		0.30 0.40 0.50	0.40 0.50 0.60	dB dB dB	0.1 to 1.0 GHz 1.0 to 2.2 GHz 2.2 to 3.0 GHz	
Isolation	ISO	30 25 20	35 30 25		dB dB dB	0.1 to 1.0 GHz 1.0 to 2.2 GHz 2.2 to 3.0 GHz	
Return loss	S11		15		dB	0.1 to 3.0 GHz	
3rd Order Input Intercept Point	IIP3	+60	+70		dBm	0.1 to 3.0 GHz, $\Delta F = 1$ MHz, PIN = +20 dBm/tone	
Input 0.1 dB compression point	P0.1dB		+36		dBm	0.1 to 3.0 GHz, ANT to RF1 and RF2	
2nd harmonic	2fo		+83	7	dBc	0.1~3GHz, PIN = +26 dBm	
3rd harmonic	3fo		+70		dBc	0.1~3GHz, PIN = +26 dBm	
Switching on time			2		us	50% VCTL to 10/90% RF	
Switching off time			2		us	50% VCTL to 90/10% RF	
Startup time			5		us	Shutdown state to any RF switch state	

Absolute Maximum Ratings

Table 5. Maximum ratings

Parameters	Symbol	Minimum	Maximum	Units
Supply voltage	V_{DD}	+2.5	+3.0	V
Digital control voltage	V _{CTL}	0	+3.0	V
RF input power	P _{IN}		+36	dBm
Operating temperature	T_OP	-30	+85	$^{\circ}$ C
Storage temperature	T _{STG}	- 55	+150	$^{\circ}\mathbb{C}$
Electrostatic discharge: Human Body Model (HBM), Class 1C Machine Model (MM), Class A	ESD		1000 100	v v

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.



Package Outline Dimension

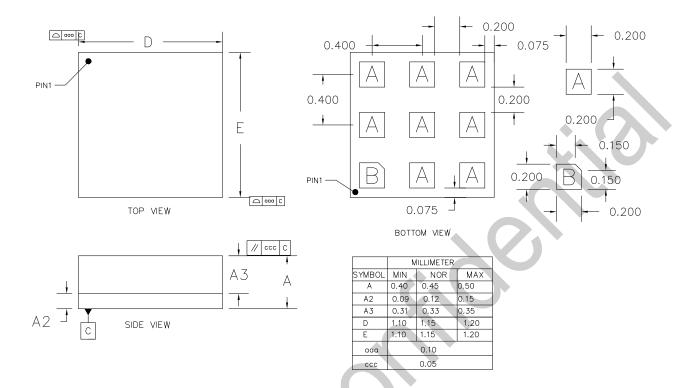


Figure 4. Package outline dimension



Reflow Chart

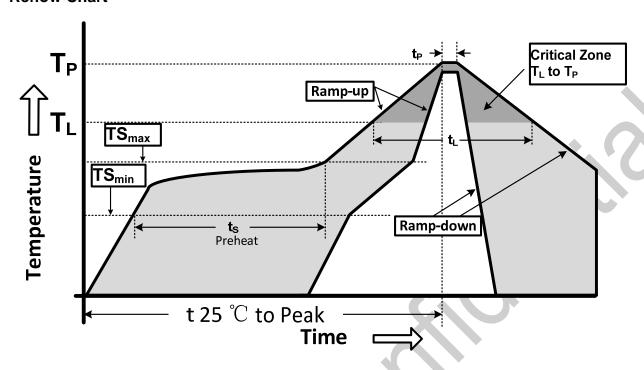


Figure 5. Recommended Lead-Free Reflow Profile

Table 6 Reflow condition

auto o itolioni contantioni				
Lead-Free Assembly, Convection, IR/Convection				
3°C/second max.				
150°C to 200°C				
60 - 180 seconds				
60 - 150 seconds				
260 ℃				
20 - 40 seconds				
6°C/second max.				
8 minutes max.				

ESD Sensitivity

Integrated circuits are ESD sensitive and can be damaged by static electric charge. Proper ESD protection techniques should be used when handling these devices.

RoHS Compliant

This product does not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE), and are considered RoHS compliant.

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